

# IGBT - Power, Co-PAK N-Channel, Field Stop VII (FS7), Non-SCR, TO247-3L 1200 V, 1.7 V, 100 A FGY100T120SWD

## **Description**

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3-lead package, FGY100T120SWD offers the optimum performance with low switching and conduction losses for high-efficiency operations in various applications like Solar, UPS, and ESS.

#### **Features**

- Maximum Junction Temperature  $T_I = 175^{\circ}C$
- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- Smooth and Optimized Switching
- Low Switching Loss
- RoHS Compliant

#### **Applications**

- Boost and Inverter in Solar System
- UPS
- Energy Storage System

#### MAXIMUM RATINGS (T, I = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit
Collector-to-Emitter Voltage		V <sub>CES</sub>	1200	V
Gate-to-Emitter Voltage	Gate-to-Emitter Voltage		±20	V
Transient Gate-to-Emitter V	oltage		±30	V
Collector Current	T <sub>C</sub> = 25°C (Note 1)	I <sub>C</sub>	200	Α
	T <sub>C</sub> = 100°C		100	
Power Dissipation	T <sub>C</sub> = 25°C	P <sub>D</sub>	866	W
	T <sub>C</sub> = 100°C		433	
Pulsed Collector Current	$T_C = 25^{\circ}C$ , $t_P = 10 \mu s$ (Note 2)	I <sub>CM</sub>	400	Α
Diode Forward Current	T <sub>C</sub> = 25°C	I <sub>F</sub>	200	Α
	T <sub>C</sub> = 100°C		100	
Pulsed Diode Maximum Forward Current	$T_C = 25^{\circ}C$ , $t_P = 10 \mu s$ (Note 2)	I <sub>FM</sub>	400	Α
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	–55 to +175	°C
Lead Temperature for Soldering Purposes		TL	260	°C

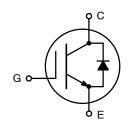
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

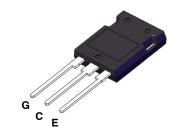
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- 1. Value limit by bond wire
- 2. Repetitive rating: Pulse width limited by max. Junction temperature

BV <sub>CES</sub>	V <sub>CE(SAT)</sub>	I <sub>C</sub>
1200 V	1.7 V	100 A

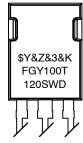
#### PIN CONNECTIONS





TO247-3LD CASE 340CD

#### **MARKING DIAGRAM**



\$Y = onsemi Logo &Z = Assembly Plant Code &3 = 3-Digit Date Code &K = 2-Digit Lot Traceability Code

FGY100T120SWD = Specific Device code

# **ORDERING INFORMATION**

Device	Package	Shipping
FGY100T120SWD	TO-247-3LD (Pb-Free)	30 Units / Tube

# THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT	$R_{\theta JC}$	0.17	°C/W
Thermal Resistance, Junction-to-Case for Diode		0.29	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

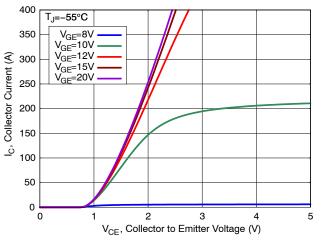
# **ELECTRICAL CHARACTERISTICS OF IGBT** (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	1	•				
Collector-to-Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE} = 0 \text{ V}, I_{C} = 5 \text{ mA}$	1200			V
Collector-to-Emitter Breakdown Voltage Temperature Coefficient	ΔBV <sub>CES</sub> / ΔΤ <sub>J</sub>			1.5		V/°C
Zero Gate Voltage Collector Current	I <sub>CES</sub>	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = V <sub>CES</sub>			40	μΑ
Gate-to-Emitter Leakage Current	I <sub>GES</sub>	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0 V			±400	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GE(TH)</sub>	V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 100 mA	5.6	6.55	7.4	V
Collector-to-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 25°C	1.35	1.69	2.0	
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 175°C		2.26		
DYNAMIC CHARACTERISTICS						
Input Capacitance	C <sub>IES</sub>	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 30 V, f = 1 MHz		8489		pF
Output Capacitance	C <sub>OES</sub>			320		
Reverse Transfer Capacitance	C <sub>RES</sub>			41.4		
Total Gate Charge	$Q_{G}$	V <sub>CE</sub> = 600 V, V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A		284		nC
Gate-to-Emitter Charge	$Q_{GE}$			72.4		
Gate-to-Collector Charge	Q <sub>GC</sub>			101		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CE} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, I_{C} = 50 \text{ A},$ $R_{G} = 4.7 \Omega, T_{J} = 25^{\circ}\text{C}$		46.4		ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{G} = 4.7 \Omega, T_{J} = 25^{\circ}C$		209.6		
Rise Time	t <sub>r</sub>			30.4		
Fall Time	t <sub>f</sub>			58		
Turn-On Switching Loss	E <sub>on</sub>			3.1		mJ
Turn-Off Switching Loss	E <sub>off</sub>			1.6		
Total Switching Loss	E <sub>ts</sub>			4.7		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CE} = 600 \text{ V}, V_{GE} = 0/15 \text{ V}, \\ I_{C} = 100 \text{ A}, R_{G} = 4.7 \Omega, T_{J} = 25^{\circ}\text{C}$		46.4		ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_C = 100 \text{ A}, R_G = 4.7 \Omega, T_J = 25^{\circ}\text{C}$		168		mJ
Rise Time	t <sub>r</sub>			72		
Fall Time	t <sub>f</sub>			51.2		
Turn-On Switching Loss	E <sub>on</sub>			8.1		
Turn-Off Switching Loss	E <sub>off</sub>			2.8		
Total Switching Loss	E <sub>ts</sub>	1		10.9		

# **ELECTRICAL CHARACTERISTICS OF IGBT** ( $T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GE} = 0/15 \text{ V}, I_{C} = 50 \text{ A}, V_{CE} = 600 \text{ V},$ $R_{G} = 4.7 \Omega, T_{J} = 175^{\circ}\text{C}$		38.4		ns
Turn-Off Delay Time	t <sub>d(off)</sub>			244.8		
Rise Time	t <sub>r</sub>			28.8		
Fall Time	t <sub>f</sub>			92.8		
Turn-On Switching Loss	E <sub>on</sub>			4.9		mJ
Turn-Off Switching Loss	E <sub>off</sub>			2.4		
Total Switching Loss	E <sub>ts</sub>			7.3		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GE</sub> = 0/15 V, I <sub>C</sub> = 100 A,		41.6		ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{CE} = 600 \text{ V}, R_G = 4.7 \Omega, T_J = 175^{\circ}\text{C}$		196.8		
Rise Time	t <sub>r</sub>			64		
Fall Time	t <sub>f</sub>			76.8		1
Turn-On Switching Loss	E <sub>on</sub>			11.3		mJ
Turn-Off Switching Loss	E <sub>off</sub>			3.9		-
Total Switching Loss	E <sub>ts</sub>			15.2		
DIODE CHARACTERISTICS				1		•
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 100 A, T <sub>J</sub> = 25°C	1.62	1.82	2.22	V
		I <sub>F</sub> = 100 A, T <sub>J</sub> = 175°C		1.87		1
DIODE SWITCHING CHARACTERIST	IC, INDUCTIVE L	OAD				
Reverse Recovery Time	t <sub>rr</sub>	$V_R = 600 \text{ V}, I_F = 50 \text{ A},$ $dI_F/dt = 1000 \text{ A/}\mu\text{s}, T_J = 25^{\circ}\text{C}$		152		ns
Reverse Recovery Charge	Q <sub>rr</sub>			2977		nC
Reverse Recovery Energy	E <sub>rec</sub>			0.9		mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>			39		Α
Reverse Recovery Time	t <sub>rr</sub>	$V_{R} = 600 \text{ V}, I_{F} = 100 \text{ A},$ $dI_{F}/dt = 1000 \text{ A/}\mu\text{s}, T_{J} = 25^{\circ}\text{C}$		261		ns
Reverse Recovery Charge	Q <sub>rr</sub>			5636		nC
Reverse Recovery Energy	E <sub>rec</sub>			1.8		mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>			43		Α
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> = 600 V, I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 1000 A/μs, T <sub>J</sub> = 175°C		192		ns
Reverse Recovery Charge	Q <sub>rr</sub>			5275		nC
Reverse Recovery Energy	E <sub>rec</sub>			1.6		mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>			55		Α
Reverse Recovery Time	t <sub>rr</sub>	V <sub>R</sub> = 600 V, I <sub>F</sub> = 100 A,		358		ns
Reverse Recovery Charge	Q <sub>rr</sub>	dl <sub>F</sub> /dt = 1000 A/μs, T <sub>J</sub> = 175°C		10858		nC
Reverse Recovery Energy	E <sub>rec</sub>			3.6		mJ
Peak Reverse Recovery Current	I <sub>RRM</sub>			61		Α
		<u> </u>		+	<b>.</b>	

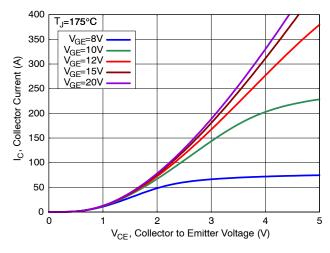
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



400 T<sub>J</sub>=25°C V<sub>GE</sub>=8V V<sub>GE</sub>=10V V<sub>GE</sub>=12V 350 Collector Current (A) 300 V<sub>GE</sub>=15V V<sub>GE</sub>=20V 250 200 150 <u>ن</u> 100 50 0 5 V<sub>CE</sub>, Collector to Emitter Voltage (V)

Figure 1. Output Characteristics

Figure 2. Output Characteristics



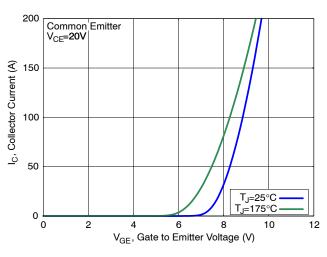
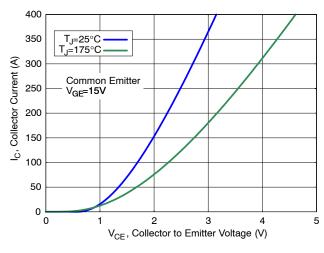


Figure 3. Output Characteristics

Figure 4. Transfer Characteristics



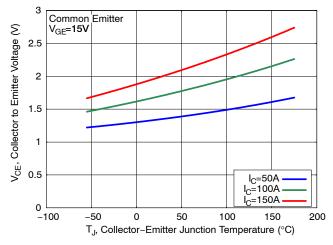


Figure 5. Saturation Characteristics

Figure 6. Saturation Voltage vs. Junction Temperature

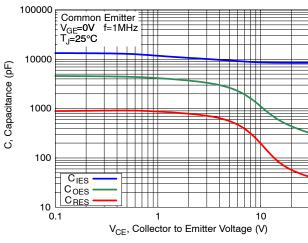


Figure 7. Capacitance Characteristics

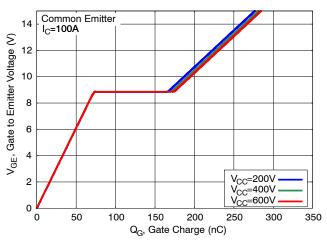


Figure 8. Gate Charge Characteristics

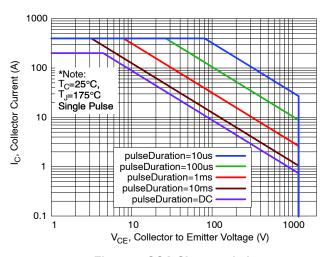


Figure 9. SOA Characteristics

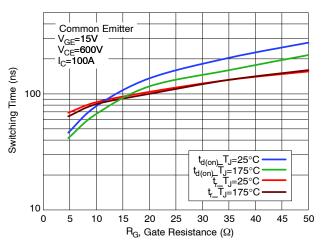


Figure 10. Turn-On Switching Time vs. Gate Resistance

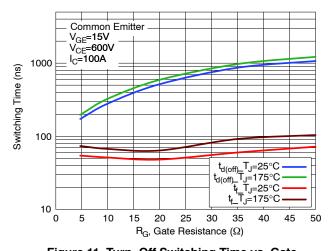


Figure 11. Turn-Off Switching Time vs. Gate Resistance

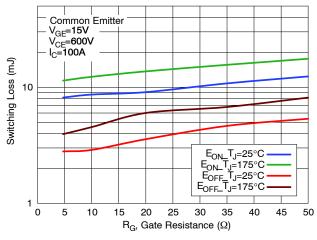


Figure 12. Switching Loss vs. Gate Resistance

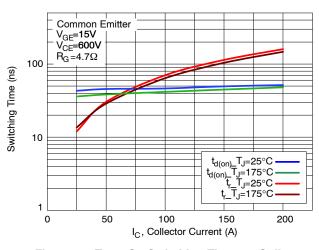
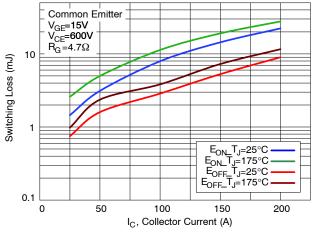


Figure 13. Turn-On Switching Time vs. Collector Current

Figure 14. Turn-Off Switching Time vs. Collector Current



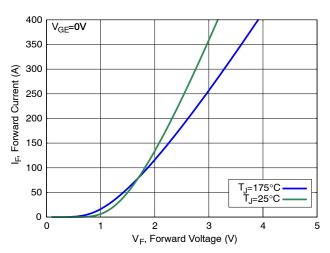
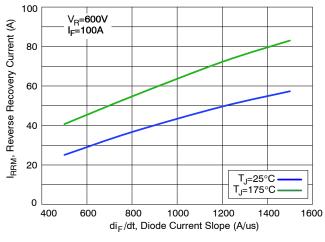


Figure 15. Switching Loss vs. Collector Current

Figure 16. Diode Forward Characteristics



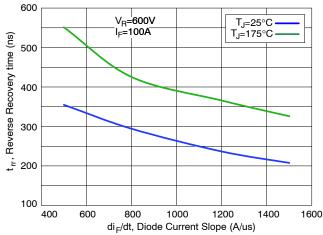


Figure 17. Diode Reverse Recovery Current

Figure 18. Diode Reverse Recovery Time

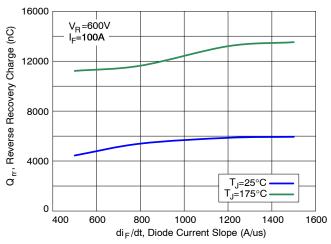


Figure 19. Diode Stored Charge Characteristics

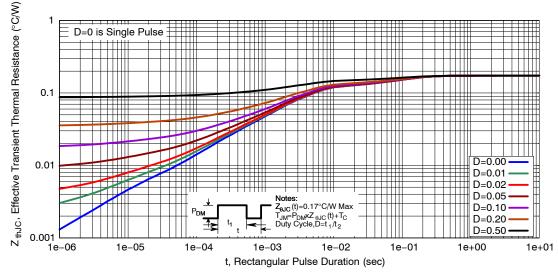


Figure 20. Transient Thermal Impedance of IGBT

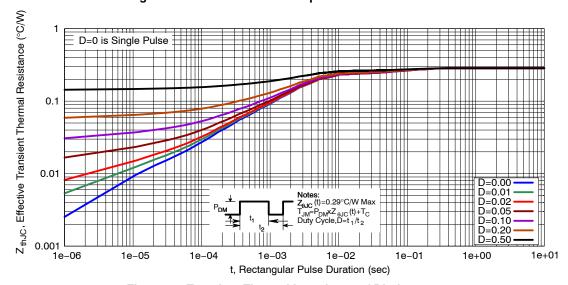


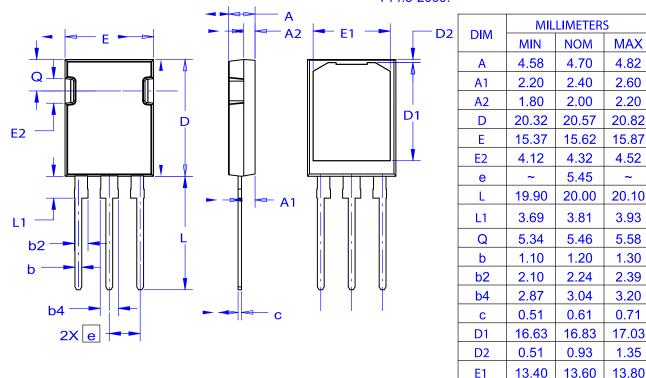
Figure 21. Transient Thermal Impedance of Diode

#### PACKAGE DIMENSIONS

TO-247-3LD CASE 340CD **ISSUE A** 

#### NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS MOLD FLASH AND TIE BAR PROTRUSIONS.
- D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.



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